



ST6215L/25L

LOW VOLTAGE 8-BIT ROM MCUs WITH A/D CONVERTER, TWO TIMERS, OSCILLATOR SAFEGUARD & SAFE RESET

■ Memories

- 2K or 4K bytes Program memory with read-out protection
- 64 bytes RAM

■ Clock, Reset and Supply Management

- Enhanced reset system
- Clock sources: crystal/ceramic resonator or RC network, external clock
- 2 Power Saving Modes: Wait and Stop

■ Interrupt Management

- 4 interrupt vectors plus NMI and RESET
- 20 external interrupt lines (on 2 vectors)
- 1 external non-interrupt line

■ 20 I/O Ports

- 20 multifunctional bidirectional I/O lines
- 16 alternate function lines
- 8 high sink outputs (12mA)

■ 2 Timers

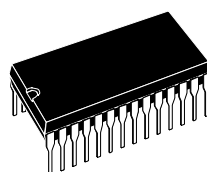
- Configurable watchdog timer
- 8-bit timer/counter with a 7-bit prescaler

■ Analog Peripheral

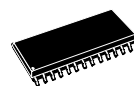
- 4-bit ADC with 16 input channels

■ Instruction Set

- 8-bit data manipulation
- 40 basic instructions
- 9 addressing modes
- Bit manipulation



PDIP28



S028



SSOP28

(See Section 1.3 for Ordering Information)

■ Development Tools

- Full hardware/software development package

Device Summary

Features	ST6215L	ST6225L
Program memory - bytes	2K	4K
RAM - bytes	64	
Operating Supply	2.4V to 3.9V	
Clock Frequency	4MHz Max	
Operating Temperature	0°C to +70°C	
Packages	PDIP28 / SO28 / SSOP28	

Rev. 1.1

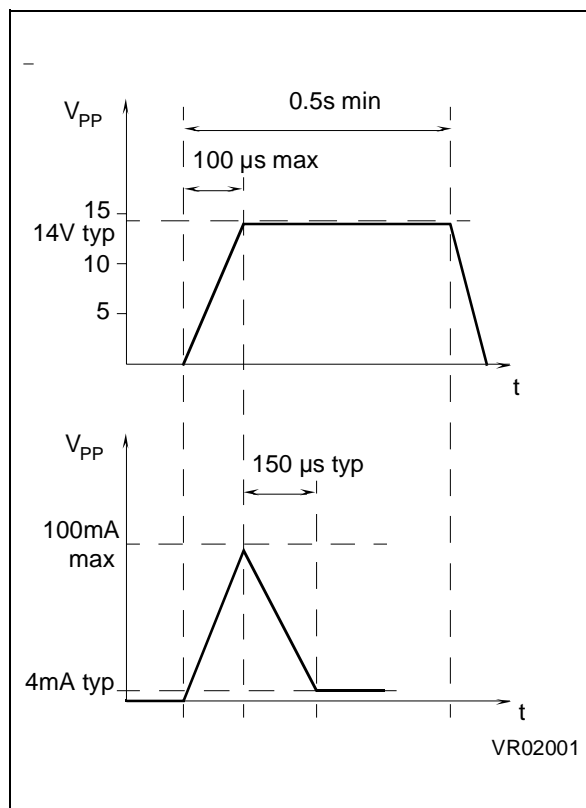
1 GENERAL DESCRIPTION

1.1 INTRODUCTION

The ST6215L/25L are low voltage mask programmed ROM version of ST62T15C,T25C OTP devices.

They offer the same functionality as OTP devices, selecting as ROM options the options defined in the programmable option byte of the OTP version, with the exception of the LVD Reset and the OSG that are not available.

Figure 1. Programming wave form

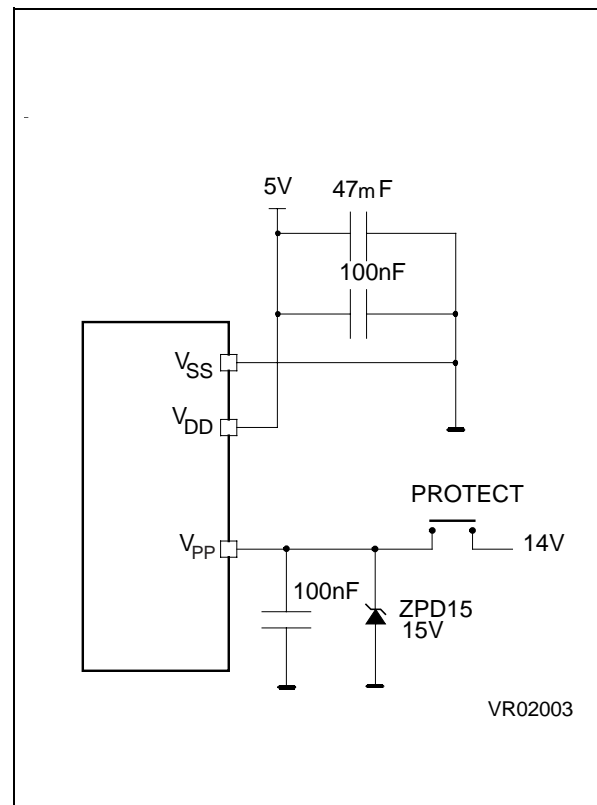


1.2 ROM READOUT PROTECTION

If the ROM READOUT PROTECTION option is selected, a protection fuse can be blown to prevent any access to the program memory content.

In case the user wants to blow this fuse, high voltage must be applied on the V_{PP} pin.

Figure 2. Programming Circuit



Note: ZPD15 is used for overvoltage protection

1.3 ORDERING INFORMATION

The following section deals with the procedure for transfer of customer codes to STMicroelectronics.

1.3.1 Transfer of Customer Code

Customer code is made up of the ROM contents and the list of the selected mask options. The ROM contents are to be sent on diskette, or by electronic means, with the hexadecimal file generated by the development tool. All unused bytes must be set to FFh.

The selected mask options are communicated to STMicroelectronics using the correctly filled OPTION LIST appended.

1.3.2 Listing Generation and Verification

When STMicroelectronics receives the user's ROM contents, a computer listing is generated from it. This listing refers exactly to the mask which will be used to produce the specified MCU. The listing is then returned to the customer who must thoroughly check, complete, sign and return it to STMicroelectronics. The signed listing forms a part of the contractual agreement for the creation of the specific customer mask.

The STMicroelectronics Sales Organization will be pleased to provide detailed information on contractual points.

Table 1. ROM Memory Map for ST6215L

Device Address	Description
0000h-087Fh	Reserved
0880h-0F9Fh	User ROM
0FA0h-0FEFh	Reserved
0FF0h-0FF7h	Interrupt Vectors
0FF8h-0FFBh	Reserved
0FFCh-0FFDh	NMI Interrupt Vector
0FFEh-0FFFh	Reset Vector

Table 2. ROM Memory Map for ST6225L

Device Address	Description
0000h-007Fh	Reserved
0080h-0F9Fh	User ROM
0FA0h-0FEFh	Reserved
0FF0h-0FF7h	Interrupt Vectors
0FF8h-0FFBh	Reserved
0FFCh-0FFDh	NMI Interrupt Vector
0FFEh-0FFFh	Reset Vector

Table 3. ROM version Ordering Information

Sales Type	ROM	Temperature Range	Package
ST6215LB1/XXX	1836 Bytes	0 to +70°C	PDIP28
ST6215LM1/XXX			PSO28
ST6215LN1/XXX			SSOP28
ST6225LB1/XXX	3884 Bytes		PDIP28
ST6225LM1/XXX			PSO28
ST6225LN1/XXX			SSOP28

ST6215L/25L MICROCONTROLLER OPTION LIST

Customer:
 Address:

 Contact:
 Phone:
 Reference:

STMicroelectronics references:

Device: ☐ ST6215L (2 KB) ☐ ST6225L (4 KB)

Package: ☐ Dual in Line Plastic
☐ Small Outline Plastic with conditioning
☐ Shrink Small Outline Plastic with conditioning

Conditioning option: ☐ Standard (Tube) ☐ Tape & Reel

Temperature Range: ☐ 0°C to + 70°C

Marking: ☐ Standard marking
☐ Special marking:
 PDIP28 (10 char. max):
 PSO28 (8 char. max):
 SSOP28 (11 char. max):

Authorized characters are letters, digits, '.', '-', '/' and spaces only.

Watchdog Selection: ☐ Software Activation ☐ Hardware Activation

Timer pull-up: ☐ Enabled ☐ Disabled

NMI pull-up: ☐ Enabled ☐ Disabled

Oscillator Selection: ☐ Quartz crystal / Ceramic resonator
☐ RC network

Readout Protection: ☐ Enabled:
 ☐ Fuse is blown by STMicroelectronics
 ☐ Fuse can be blown by the customer
☐ Disabled

External STOP Mode Control: ☐ Enabled ☐ Disabled

Comments:

Oscillator Frequency in the application:
 Supply Operating Range in the application:
 Notes:
 Date:
 Signature:

2 ELECTRICAL CHARACTERISTICS

2.1 ABSOLUTE MAXIMUM RATINGS

This product contains devices to protect the inputs against damage due to high static voltages, however it is advisable to take normal precaution to avoid application of any voltage higher than the specified maximum rated voltages.

For proper operation it is recommended that V_I and V_O be higher than V_{SS} and lower than V_{DD} . Reliability is enhanced if unused inputs are connected to an appropriate logic voltage level (V_{DD} or V_{SS}).

Power Considerations. The average chip-junction temperature, T_J , in Celsius can be obtained from:

$$T_J = T_A + P_D \times R_{thJA}$$

Where: T_A = Ambient Temperature.

R_{thJA} = Package thermal resistance (junction-to ambient).

$P_D = P_{int} + P_{port}$.

$P_{int} = I_{DD} \times V_{DD}$ (chip internal power).

P_{port} = Port power dissipation (determined by the user).

Symbol	Parameter	Value	Unit
V_{DD}	Supply Voltage	-0.3 to 7.0	V
V_I	Input Voltage	$V_{SS} - 0.3$ to $V_{DD} + 0.3^{(1)}$	V
V_O	Output Voltage	$V_{SS} - 0.3$ to $V_{DD} + 0.3^{(1)}$	V
I_O	Current Drain per Pin Excluding V_{DD} , V_{SS}	± 10	mA
$I_{V_{DD}}$	Total Current into V_{DD} (source)	50	mA
$I_{V_{SS}}$	Total Current out of V_{SS} (sink)	50	mA
T_J	Junction Temperature	150	°C
T_{STG}	Storage Temperature	-60 to 150	°C

Notes:

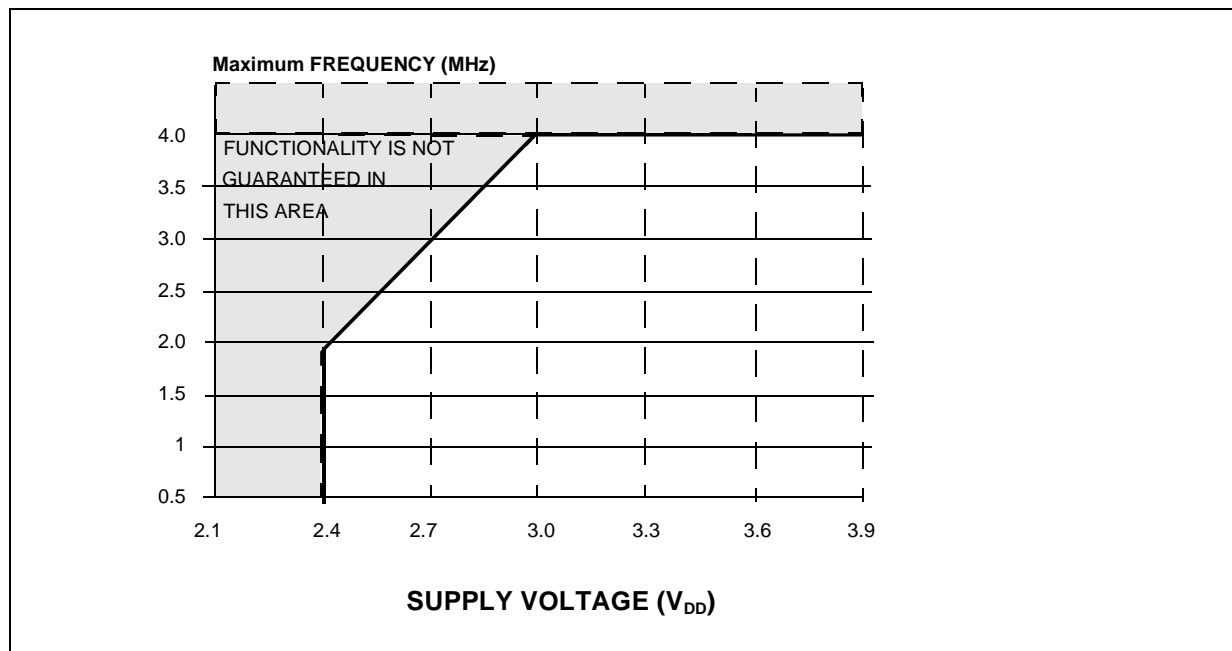
- Stresses above those listed as "absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.
- (1) Within these limits, clamping diodes are guaranteed to be not conductive. Voltages outside these limits are authorised as long as injection current is kept within the specification.

2.2 RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
T_A	Operating Temperature	1 Suffix Version	0		70	°C
V_{DD}	Operating Supply Voltage	$f_{OSC} = 2\text{MHz}$ $f_{OSC} = 4\text{MHz}$	2.4 3		3.9 3.9	V
f_{OSC}	Oscillator Frequency ²⁾	$V_{DD} = 2.4\text{V}$ $V_{DD} = 3.0\text{V}$	0 0		2.0 4.0	MHz
I_{INJ+}	Pin Injection Current (positive)	$V_{DD} = 2.4$ to 3.9V			+5	mA
I_{INJ-}	Pin Injection Current (negative)	$V_{DD} = 2.4$ to 3.9V			-5	mA

Notes:

1. Care must be taken in case of negative current injection, where adapted impedance must be respected on analog sources to not affect the A/D conversion. For a -1mA injection, a maximum 10 K Ω is recommended.
2. An oscillator frequency above 1MHz is recommended for reliable A/D results

Figure 3. Maximum Operating FREQUENCY (Fmax) Versus SUPPLY VOLTAGE (V_{DD})

The shaded area is outside the recommended operating range; device functionality is not guaranteed under these conditions.

2.3 DC ELECTRICAL CHARACTERISTICS

($T_A = 0$ to $+70^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
V_{IL}	Input Low Level Voltage All Input pins				$V_{DD} \times 0.2$	V
V_{IH}	Input High Level Voltage All Input pins		$V_{DD} \times 0.8$			V
V_{Hys}	Hysteresis Voltage ⁽¹⁾ All Input pins	$V_{DD} = 3V$	0.2			V
V_{OL}	Low Level Output Voltage All Output pins	$V_{DD} = 3.0V; I_{OL} = +10\mu A$ $V_{DD} = 3.0V; I_{OL} = +3.0mA$ $V_{DD} = 2.4V; I_{OL} = +1.5mA$			0.1 0.8 0.8	V
	Low Level Output Voltage 20 mA Sink I/O pins	$V_{DD} = 3.0V; I_{OL} = +10\mu A$ $V_{DD} = 3.0V; I_{OL} = +8mA$ $V_{DD} = 3.0V; I_{OL} = +12mA$ $V_{DD} = 2.4V; I_{OL} = +5mA$			0.1 0.8 1.3 0.8	
V_{OH}	High Level Output Voltage All Output pins	$V_{DD} = 3.0V; I_{OH} = -10\mu A$ $V_{DD} = 3.0V; I_{OH} = -1.5mA$ $V_{DD} = 2.4V; I_{OH} = -10\mu A$	2.9 2.0 2.3			V
R_{PU}	Pull-up Resistance	All Input pins	100	250	600	K Ω
		RESET pin	400	600	1200	
I_{IL} I_{IH}	Input Leakage Current All Input pins but RESET	$V_{IN} = V_{SS}$ (No Pull-Up configured) $V_{IN} = V_{DD}$		0.1	1.0	μA
	Input Leakage Current RESET pin	$V_{IN} = V_{SS}$ $V_{IN} = V_{DD}$	-8	-16	-30 10	
I_{DD}	Supply Current in RESET Mode	$V_{RESET} = V_{SS}$ $f_{OSC} = 4MHz$			1.5	mA
	Supply Current in RUN Mode ⁽²⁾	$V_{DD} = 3.0V$ $f_{INT} = 4MHz$			1.5	mA
	Supply Current in WAIT Mode ⁽³⁾	$V_{DD} = 3.0V$ $f_{INT} = 4MHz$			0.5	mA
	Supply Current in STOP Mode ⁽³⁾	$I_{LOAD} = 0mA$ $V_{DD} = 3.0V$			2	μA

Notes:

(1) Hysteresis voltage between switching levels

(2) All peripherals running

(3) All peripherals in stand-by

DC ELECTRICAL CHARACTERISTICS (Cont'd)

2.4 AC ELECTRICAL CHARACTERISTICS

(($T_A = 0$ to $+70^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
t_{REC}	Supply Recovery Time ⁽¹⁾		100			ms
f_{RC}	Internal frequency with RC oscillator ^{2) 3)}	VDD=3.0V R=47k Ω R=100k Ω R=470k Ω	2.5 1.4 450	3 1.7 520	3.5 2.1 600	MHz MHz kHz
C_{IN}	Input Capacitance	All Inputs Pins			10	pF
C_{OUT}	Output Capacitance	All Outputs Pins			10	pF

Notes:

1. Period for which V_{DD} has to be connected at 0V to allow internal Reset function at next power-up.
2. An oscillator frequency above 1MHz is recommended for reliable A/D results.
3. Measure performed with OSCin pin soldered on PCB, with an around 2pF equivalent capacitance.

2.5 A/D CONVERTER CHARACTERISTICS

($T_A = 0$ to $+70^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Res	Resolution			8		Bit
A_{TOT}	Total Accuracy ^{(1) (2)}	$f_{OSC} > 1.2\text{MHz}$, $V_{DD}=3.0\text{V}$ $f_{OSC} > 1.2\text{MHz}$, $V_{DD}=2.4\text{V}$ $f_{OSC} > 32\text{kHz}$, $V_{DD}=3.0\text{V}$			± 25 ± 35 ± 50	mV
t_C	Conversion Time	$f_{OSC} = 2\text{MHz}$ $f_{OSC} = 4\text{MHz}$		280 140		μs
ZIR	Zero Input Reading	Conversion result when $V_{IN} = V_{SS}$	00			Hex
FSR	Full Scale Reading	Conversion result when $V_{IN} = V_{DD}$			FF	Hex
AD_I	Analog Input Current During Conversion	$V_{DD} = 4.0\text{V}$			1.0	μA
AC_{IN}	Analog Input Capacitance			2	5	pF

Notes:

- Noise at V_{DD} , $V_{SS} < 10\text{mV}$
- With oscillator frequencies less than 1MHz, the A/D Converter accuracy is decreased.

2.6 TIMER CHARACTERISTICS

(($T_A = 0$ to $+70^\circ\text{C}$ unless otherwise specified))

Symbol	Parameter	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
f_{IN}	Input Frequency on TIMER Pin				$\frac{f_{INT}}{4}$	MHz
t_W	Pulse Width at TIMER Pin	$V_{DD} = 2.4\text{V}$	250			ns

Notes:

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